

TOSHIBA Bi-CMOS INTEGRATED CIRCUIT SILICON MONOLITHIC

**TB62003P, TB62003F, TB62003FW, TB62004P, TB62004F, TB62004FW, TB62006P
TB62006F, TB62006FW, TB62007P, TB62007F, TB62007FW, TB62008P, TB62008F
TB62008FW, TB62009P, TB62009F, TB62009FW**

8CH DMOS TRANSISTOR ARRAY WITH GATE

TB62003P, TB62003F, TB62003FW
INVERTER & DMOS DRIVER

TB62004P, TB62004F, TB62004FW
THROUGH & DMOS DRIVER

TB62006P, TB62006F, TB62006FW
NAND & DMOS DRIVER

TB62007P, TB62007F, TB62007FW
AND & DMOS DRIVER

TB62008P, TB62008F, TB62008FW
NOR & DMOS DRIVER

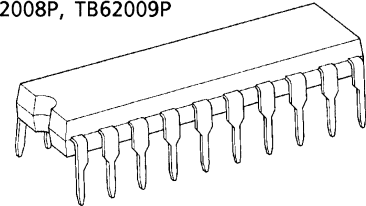
TB62009P, TB62009F, TB62009FW
OR & DMOS DRIVER

The TB62003 Series are high-voltage, high-current arrays comprised of eight N-ch DMOS pairs.

FEATURES

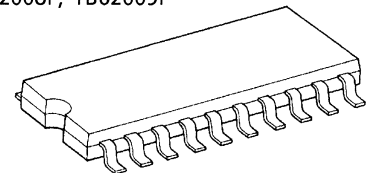
- Package : Type-P DIP-20 pin
Type-F SOP-20 pin (200 mil)
Type-FW SOL-20 pin (300 mil)
- Output rating : 35 V (Min.) / 200 mA (Max.)
- Low power

TB62003P, TB62004P
TB62006P, TB62007P
TB62008P, TB62009P



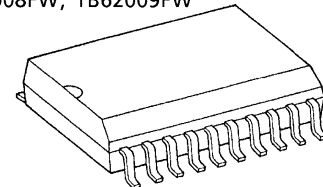
DIP20-P-300-2.54A

TB62003F, TB62004F
TB62006F, TB62007F
TB62008F, TB62009F



SOP20-P-300-1.27

TB62003FW, TB62004FW
TB62006FW, TB62007FW
TB62008FW, TB62009FW



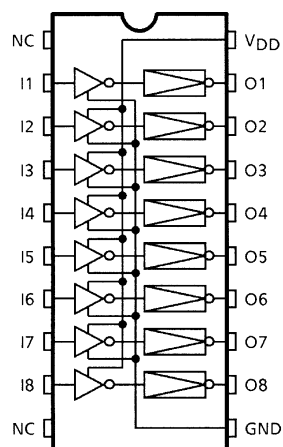
SOL20-P-300-1.27

Weight

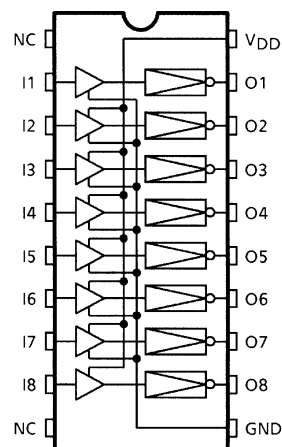
DIP20-P-300-2.54 A : 2.25 g (Typ.)
SOP20-P-300-1.27 : 0.25 g (Typ.)
SOL20-P-300-1.27 : 0.48 g (Typ.)

PIN CONNECTION (TOP VIEW)

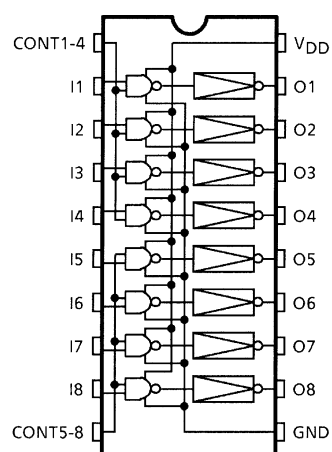
TB62003P / F / FW



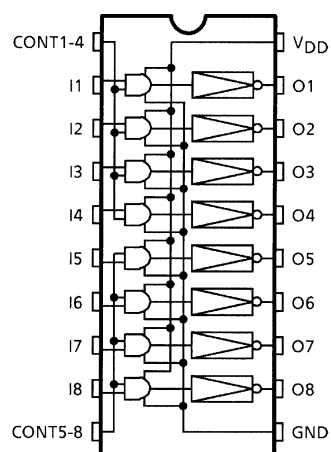
TB62004P / F / FW



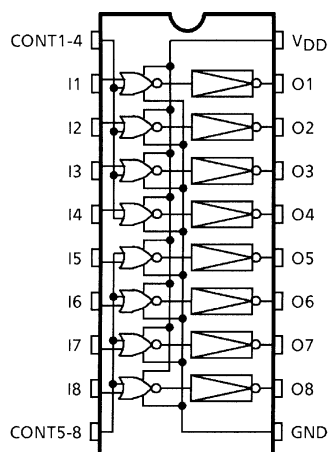
TB62003P / F / FW



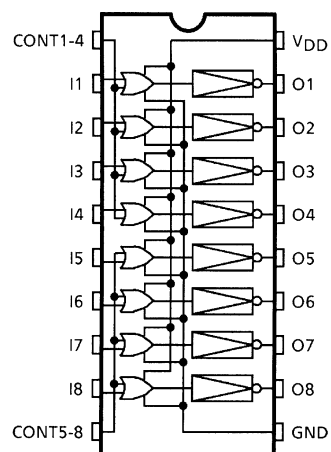
TB62007P / F / FW



TB62008P / F / FW



TB62009P / F / FW



TRUTH TABLE

TB62006P / F / FW

INPUT				OUTPUT	
I1~4	I5~8	CONT1~4	CONT5~8	O3~4	O5~8
H	X	H	X	OFF	NOT FIX
H	X	L	X	ON	NOT FIX
L	X	H	X	ON	NOT FIX
L	X	L	X	ON	NOT FIX
X	H	X	H	NOT FIX	OFF
X	H	X	L	NOT FIX	ON
X	L	X	H	NOT FIX	ON
X	L	X	L	NOT FIX	ON

X: Don't Care

TB62007P / F / FW

INPUT				OUTPUT	
I1~4	I5~8	CONT1~4	CONT5~8	O3~4	O5~8
H	X	H	X	ON	NOT FIX
H	X	L	X	OFF	NOT FIX
L	X	H	X	OFF	NOT FIX
L	X	L	X	OFF	NOT FIX
X	H	X	H	NOT FIX	ON
X	H	X	L	NOT FIX	OFF
X	L	X	H	NOT FIX	OFF
X	L	X	L	NOT FIX	OFF

X: Don't Care

TB62008P / F / FW

INPUT				OUTPUT	
I1~4	I5~8	CONT1~4	CONT5~8	O3~4	O5~8
H	X	H	X	OFF	NOT FIX
H	X	L	X	OFF	NOT FIX
L	X	H	X	OFF	NOT FIX
L	X	L	X	ON	NOT FIX
X	H	X	H	NOT FIX	OFF
X	H	X	L	NOT FIX	OFF
X	L	X	H	NOT FIX	OFF
X	L	X	L	NOT FIX	ON

X: Don't Care

TB62009P / F / FW

INPUT				OUTPUT	
I1~4	I5~8	CONT1~4	CONT5~8	O3~ 4	O5~8
H	X	H	X	ON	NOT FIX
H	X	L	X	ON	NOT FIX
L	X	H	X	ON	NOT FIX
L	X	L	X	OFF	NOT FIX
X	H	X	H	NOT FIX	ON
X	H	X	L	NOT FIX	ON
X	L	X	H	NOT FIX	ON
X	L	X	L	NOT FIX	OFF

X: Don't Care

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Supply Voltage		V _{DD}	7	V
DC Output Voltage		V _{DS}	-0.5~35	V
DC Output Current		I _{DS}	200	mA / ch
DC Input Voltage		V _{IN}	-0.4+V _{DD} +0.4	V
DC Input Current		I _{IN}	±5	mA
Input Diode Current		I _{ID}	±5	mA
Output Diode Current		I _{OK}	5	mA
Power Dissipation	P	P _D	1.47	W
	F		0.96 (Note 1)	
	FW		1.00 (Note 2)	
Operating Temperature		T _{opr}	-40~85	°C
Storage Temperature		T _{stg}	-55~150	°C

Note 1: On Glass Epoxy PCB (50 × 50 × 1.6 mm Cu 40%)

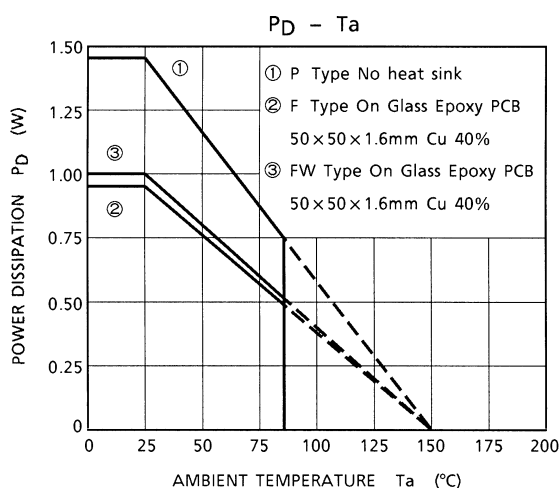
Note 2: Delated above 25°C in the proportion of 7.7 mW / °C (F Type), 8.0 mW / °C (FW Type).

RECOMMENDED OPERATING CONDITION (Ta = -40~85°C)

CHARACTERISTIC		SYMBOL	CONDITION		MIN	TYP.	MAX	UNIT
Supply Voltage Range		V _{DD}	—		4.5	—	5.5	V
DC Output Voltage		V _{DS}	—		—	—	30	V
DC Output Current	P	I _{DS}	Duty 80%	8ch On V _{DD} = 5.0 V	—	—	170	mA / ch
	F				—	—	90	
	FW				—	—	140	
	P		Duty 100%		—	—	150	
	F				—	—	80	
	FW				—	—	120	
DC Input Voltage		V _{IN}	—		GND	—	V _{DD}	V

ELECTRICAL CHARACTERISTICS (Ta = 25°C, VDD = 5.0 V)

CHARACTERISTIC	SYMBOL	TEST CIR-CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
Output Leakage Current	I _{OZ}	—	V _{DS} = 35 V	—	—	50	μA
Low-Level Output Voltage	V _{DS}	—	I _{DS} = 150 mA	—	0.70	0.8	V
		—	I _{DS} = 200 mA	—	0.94	1.2	
Output Resistance	R _{ON}	—	I _{DS} = 200 mA	—	4.7	6.0	Ω
DC Input Current	I _{IN}	—	V _{IN} = GND, V _{IN} = V _{DD}	—	—	±1.0	μA
High-Level Input Voltage	V _{IN} (H)	—	—	3.5	—	V _{DD} +0.4	V
	V _{IN} (L)	—	—	-0.4	—	1.5	
Operating Supply Current	I _{DDopr}	—	8ch On, Output open f _{IN} = 1MHz	—	2	—	μA
Output Diode Forward Voltage	V _{FK}	—	I _{OK} = 5 mA	—	0.6	—	V
Turn-On Delay	t _{ON}	—	I _{OUT} = 170 mA	—	300	—	ns
Turn-Off Delay	t _{OFF}	—	—	—	300	—	
Supply Current	I _{DD}	—	—	—	—	10	μA
Input Capacitance	C _{IN}	—	—	—	15	—	pF


PRECAUTIONS for USING

This IC does not integrate protection circuits such as overcurrent and overvoltage protectors.

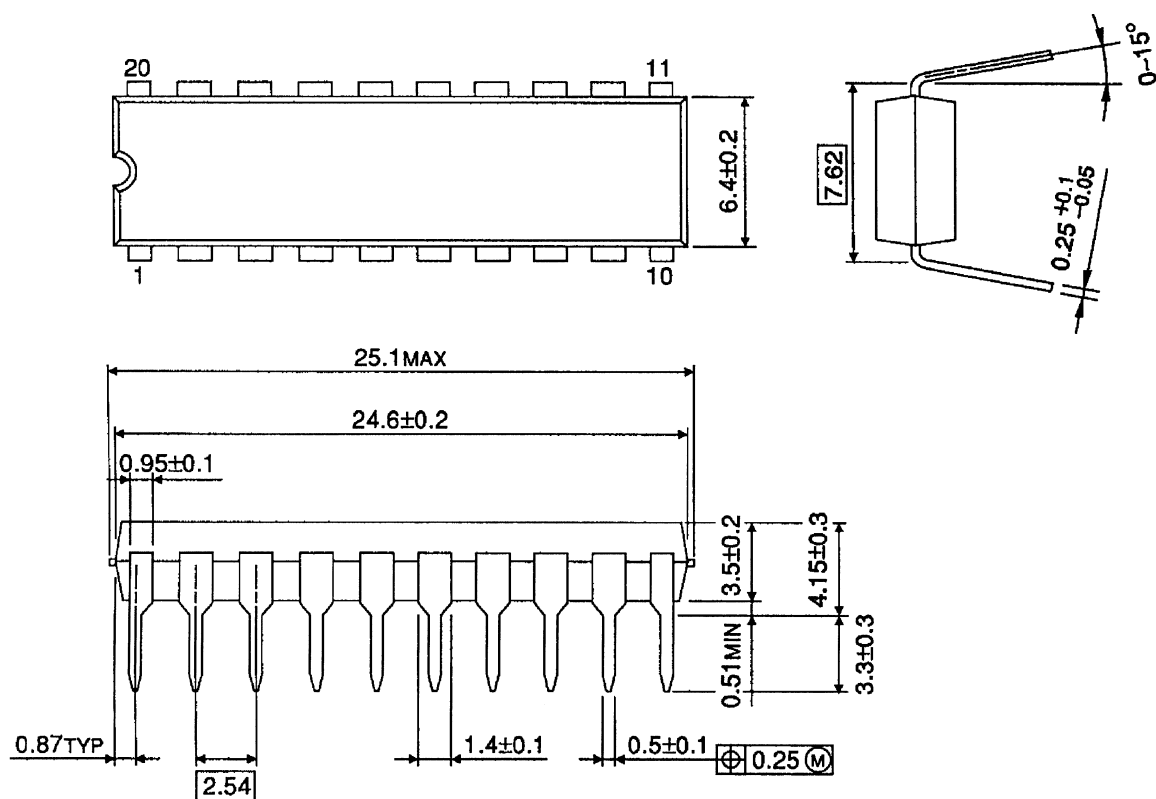
Thus, if excess current or voltage is applied to the IC, the IC may be damaged. Please design the IC so that excess current or voltage will not be applied to the IC.

Utmost care is necessary in the design of the output line, VCC (VDD) and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

PACKAGE DIMENSIONS

DIP20-P-300-2.54A

Unit: mm

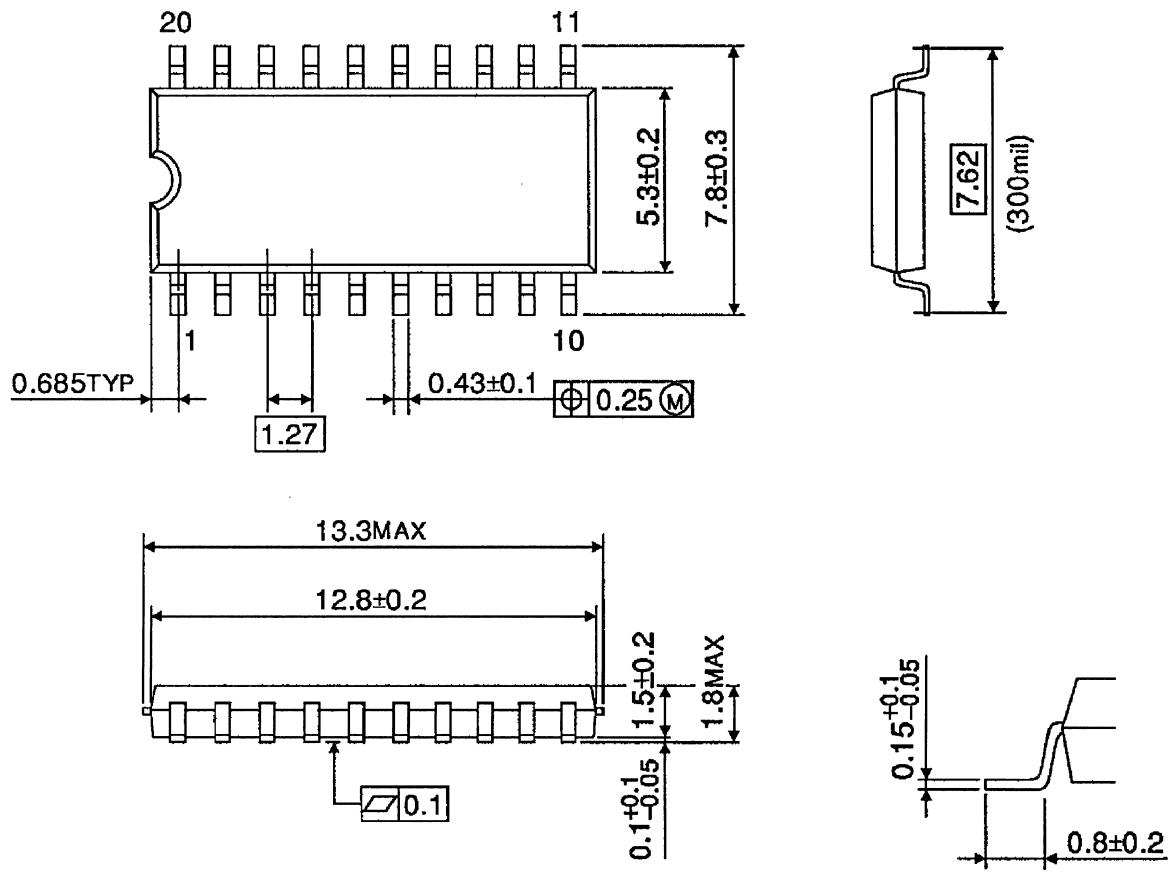


Weight: 2.25 g (Typ.)

PACKAGE DIMENSIONS

SOP20-P-300-1.27

Unit: mm

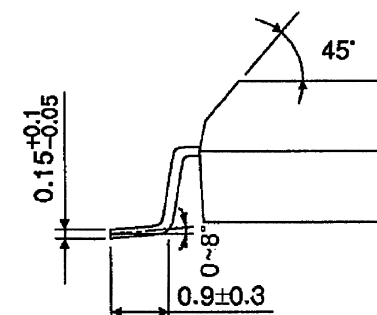
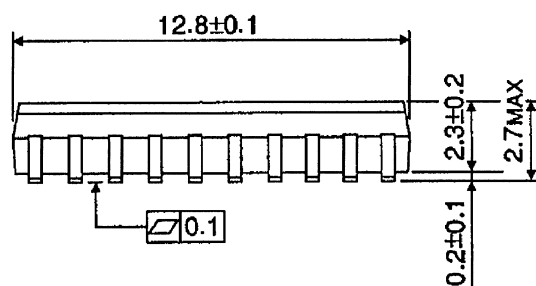
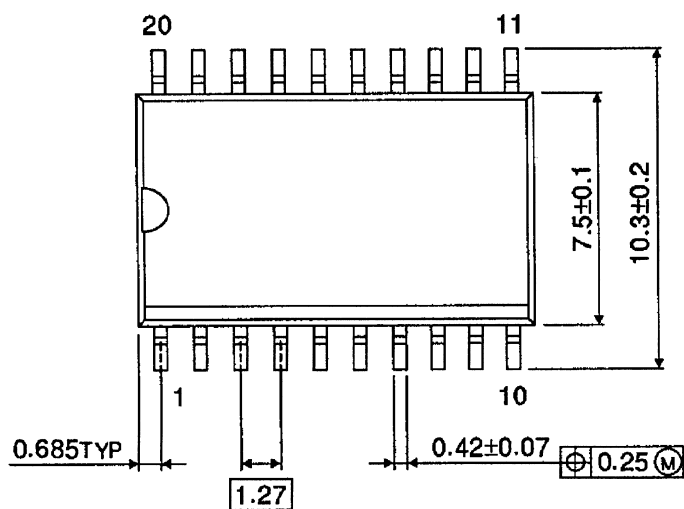


Weight: 0.25 g (Typ.)

PACKAGE DIMENSIONS

SOL20-P-300-1.27

Unit: mm



Weight: 0.48 g (Typ.)

RESTRICTIONS ON PRODUCT USE

000707EBA

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